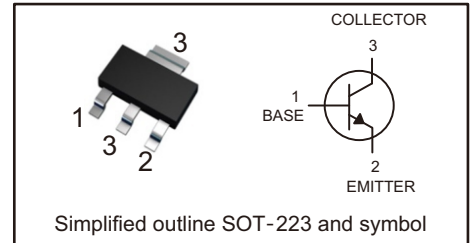




PINNING

PIN	DESCRIPTION
1	BASE
2	EMITTER
3	COLLECTOR



NPN TRANSISTOR

FEATURES

- High collector current and low VCE(SAT)
- Pb-free lead plating and halogen-free package

CLASSIFICATION OF hFE(2)

Rank	16	25
Range	100-250	160-400

MAXIMUM RATINGS (Ta =25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Collector– Base Voltage	V _{CBO}	45	V
		60	
		100	
Collector– Emitter Voltage	V _{CEO}	45	V
		60	
		80	
Emitter– Base Voltage	V _{EBO}	5	V
Collector Current — Continuous	I _c	1	A
Collector Power Dissipation	P _c	1.5	W
Thermal Resistance From Junction To Ambient	R _{θJA}	83.3	°C/W
Operation Junction and Storage Temperature Range	T _J , T _{stg}	-55~ +150	°C

ELECTRICAL CHARACTERISTICS (TA= 25°C unless otherwise noted.)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Collector-base breakdown voltage	V _{(BR)CBO}	I _c = 100uA , I _E = 0	BCP54WK	45		V
			BCP55WK	60		
			BCP56WK	100		
Collector-emitter breakdown voltage	V _{(BR)CEO}	I _c = 10mA , I _B = 0	BCX54WN	45		V
			BCX55WN	60		
			BCX56WN	80		
Emitter-base breakdown voltage	V _{(BR)EBO}	I _E = 10uA , I _c = 0	5		V	
Collector cut-off current	I _{CB0}	V _{CB} = 30V , I _E = 0			0.1	uA
Emitter cut-off current	I _{EBO}	V _{EB} = 5V , I _c = 0			0.1	uA
DC current gain	h _{FE(1)}	V _{CE} = 2V , I _c = 5mA	25			
		V _{CE} = 2V , I _c = 150mA	100		400	
		V _{CE} = 2V , I _c = 500mA	25			
Collector-emitter saturation voltage	V _{CE(sat)}	I _c = 500mA , I _B = 50mA			0.3	V
		I _c = 1A , I _B = 50mA			0.6	V
Base-emitter saturation voltage	V _{BE(sat)}	I _c = 1A , I _B = 50mA			1.2	V
Base-emitter voltage	V _{BE(ON)}	V _{CE} = 2V , I _c = 500mA			1.0	V
Transition frequency	f _T	V _{CE} = 10V , I _c = 50mA , f = 100MHz		125		MHz
Collector output capacitance	C _{ob}	V _{CB} = 10V , I _E = 0 , f = 1MHz			10	pF



TYPICAL CHARACTERISTICS

Fig 1. Current Gain vs Collector Current

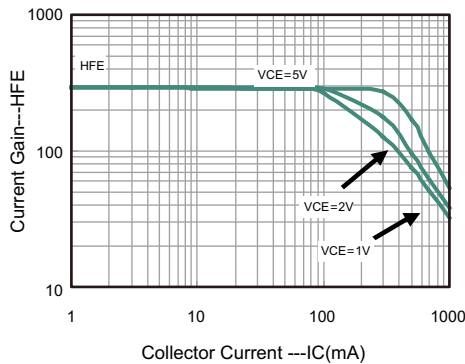


Fig 2. VCESat vs Collector Current

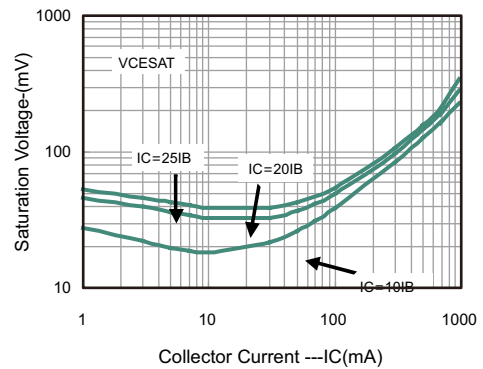


Fig 3. VBESat vs Collector Current

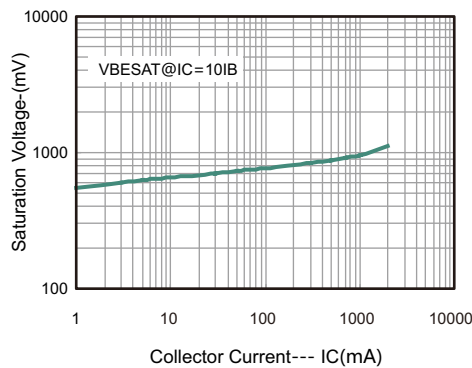


Fig 4. On Voltage vs Collector Current

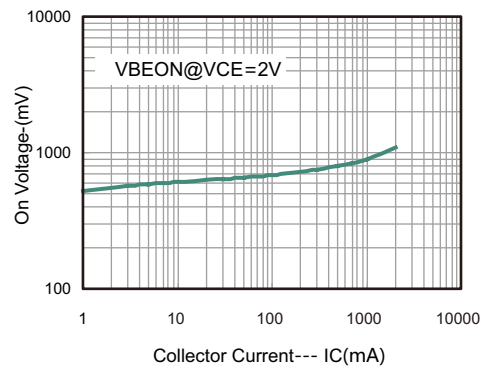


Fig 5. Typical Cut off Current Characteristics

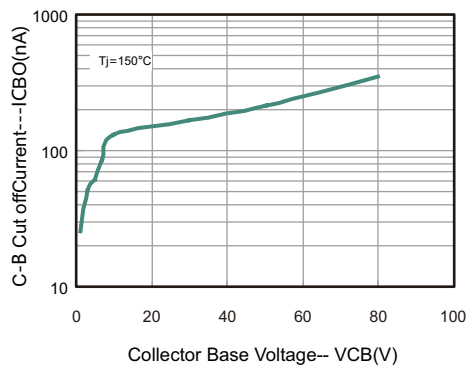


Fig 6. fT vs Collector Current

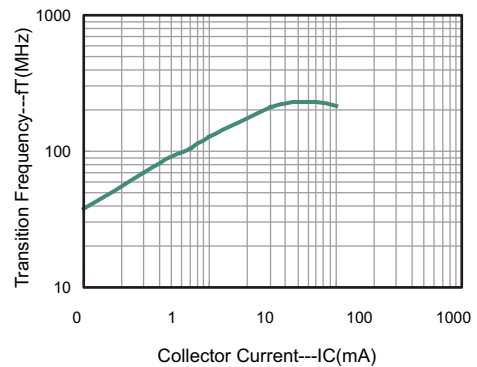
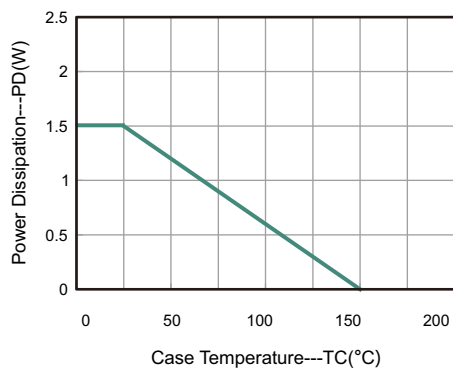
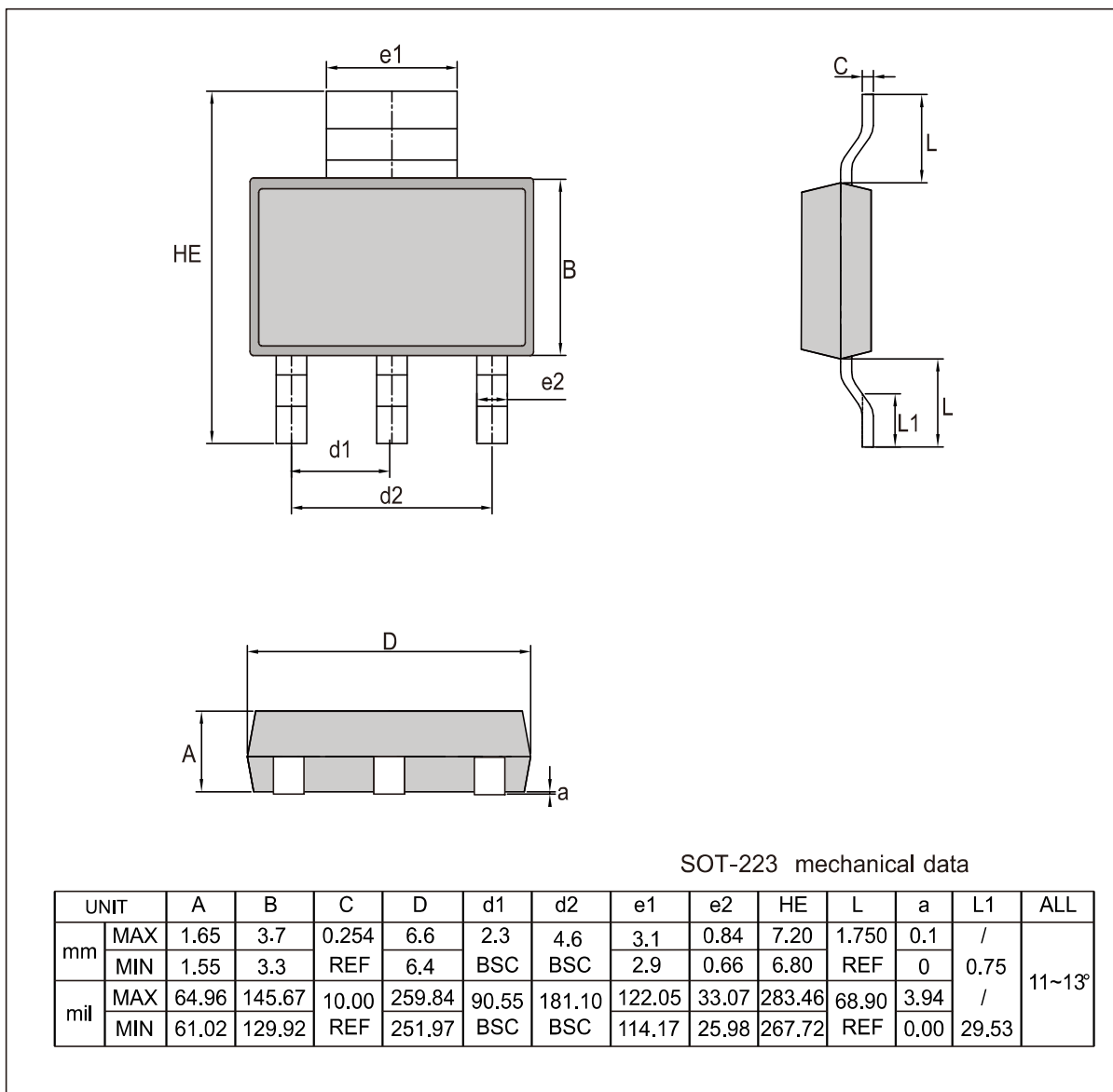


Fig 7. Power Derating Curve

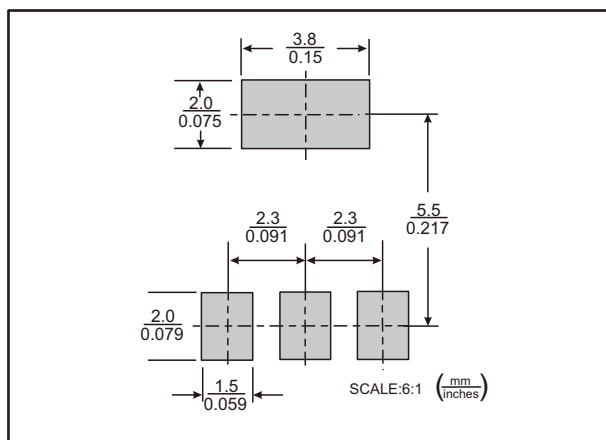




SOT-223 Package Outline Dimensions



The recommended mounting pad size



Marking

Type number	Marking code
BCP54WK	P54
BCP54WK-16	P546
BCP54WK-25	P545
BCP55WK	P55
BCP55WK-16	P556
BCP55WK-25	P555
BCP56WK	P56
BCP56WK-16	P566
BCP56WK-25	P565



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